

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>David Jacobs</td> <td>03/05/2013</td> </tr> <tr> <td>Sheng Jie Xu</td> <td>03/05/2013</td> </tr> <tr> <td>Shao Jian Chen</td> <td>03/05/2013</td> </tr> <tr> <td>Xiao Juan Ye</td> <td>03/05/2013</td> </tr> <tr> <td>Keith Lee Moore</td> <td>03/05/2013</td> </tr> </tbody> </table>	Name	Execution Date	David Jacobs	03/05/2013	Sheng Jie Xu	03/05/2013	Shao Jian Chen	03/05/2013	Xiao Juan Ye	03/05/2013	Keith Lee Moore	03/05/2013	
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Shao Jian Chen	03/05/2013												
Xiao Juan Ye	03/05/2013												
Keith Lee Moore	03/05/2013												
RECEIVING PARTY DATA													
Name:	Kemet Electronics Corporation												
Street Address:	2835 Kemet Way												
City:	Simpsonville												
State/Country:	SOUTH CAROLINA												
Postal Code:	29681												
PROPERTY NUMBERS Total: 1													
Property Type	Number												
Application Number:	13650260												
CORRESPONDENCE DATA													
Fax Number:	8663653840												
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
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Address Line 1:	200 North Main Street												
Address Line 2:	Suite 301												
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ATTORNEY DOCKET NUMBER:	16066.TA.189												
NAME OF SUBMITTER:	Joseph Guy												
Total Attachments: 3 source=Assignment#page1.tif source=Assignment#page2.tif source=Assignment#page3.tif													

OP \$40.00 13650260

**Assignment of Rights, Title and Interest in Invention
(Multiple inventors; single assignee)**

**Docket No.
16066.TA.189**

This is an Assignment of the folio wing rights, title and interest: (check all that apply):

- ☒ *United States of America rights, title and interest in the invention*
☒ *Foreign rights, title and interest in the invention*
☒ *United States Patent Application Serial No. 13/650,260*
Date of Execution: _____ Date of Filing: October 12, 2012
☐ *United States Provisional Patent Application Serial No. _____*
☐ *United States Patent No(s). _____*
☐ *International (PCT) Patent Application Serial No. _____*
☐ *Other (specify) _____*

Title of the Invention

SOLID ELECTROLYTIC CAPACITOR AND METHOD FOR MANUFACTURING SAME

Inventors (assignors)

<i>Name</i>	<i>Address</i>
<i>David Jacobs</i>	<i>2835 Kemet Way, Simpsonville SC 29681</i>
<i>Sheng Jie Xu</i>	<i>#99 Yang Pu Road, Suzhou Industrial Park, Jiangsu China 215024</i>
<i>Shao Jian Chen</i>	<i>#99 Yang Pu Road, Suzhou Industrial Park, Jiangsu China 215024</i>
<i>XiaoJuan Ye</i>	<i>#99 Yang Pu Road, Suzhou Industrial Park, Jiangsu China 215024</i>
<i>Keith Lee Moore</i>	<i>2835 Kemet Way, Simpsonville SC 29681</i>

Assignee

<i>Name</i>	<i>Address</i>
<i>Kemet Electronics Corporation 2835 Kemet Way Simpsonville SC 29681</i>	

Assignment of Rights, Title and Interest in Invention
(Multiple inventors; single assignee)

Docket No.
16066.TA.189

Whereas, we, the above-identified Inventors, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and/or patent(s) (hereinafter referred to as "Invention");

And, whereas we desire to assign our above-identified rights, title and interest in the Invention to the above-identified Assignee;

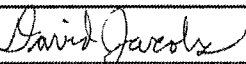

Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

We hereby assign, sell and transfer our above-identified rights, title and interest in said Invention, said application(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and an Letters Patent of the United States, and countries foreign thereto, which may be granted or have granted for said Invention, and in and to any and an reissues and reexaminations thereof, and in and to any and an priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto said Assignee;

And we hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Letters Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;

And we further agree to sign and execute an necessary and lawful future documents, including applications for foreign patents, for filing divisions, continuations and continuations-in-part of said application for patent, and/or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee or its Designee(s) may from time to time require and prepare at its own expense.

Inventors' Signatures

Name	Signature / Date
David Jacobs	 3/4/2013
Sheng Jie Xu	
Shao Jian Chen	
XiaoJuan Ye	
Keith Lee Moore	 03 / 04 / 13

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And, whereas we desire to assign our above-identified rights, title and interest in the Invention to the above-identified assignee;

Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

We hereby assign, sell and transfer our above-identified rights, title and interest in said Invention, said application(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted or have been granted for said Invention, and in and to any and all reissues and reexaminations thereof, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto said Assignee;

And we hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Letters Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;

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Name	Signature / Date
David Jacobs	
Sheng Jie Xu	Sheng Jie Xu / 2013-03-05
Shao Jian Chen	Shao Jian Chen / 2013-03-05
Xiao Juan Ye	Xiao Juan Ye / 2013-03-05
Keith Lee Moore	

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